

74LCXR162245

Low voltage CMOS 16-bit bus transceiver (3-state) with 5V tolerant I/Os and 26Ω series resistors in the outputs

Features

- 5V tolerant inputs and outputs
- High speed:
 - t_{PD} = 4.2ns (Max) at V_{CC} = 3V
- Power down protection on inputs and outputs
- Symmetrical output impedance:
 - $II_{OH}I = I_{OL} = 12mA (Min) at <math>V_{CC} = 3V$
- PCI bus levels guaranteed 12mA
- Balanced propagation delays:
 - t_{PLH} ≅ t_{PHL}
- A and B side outputs have equivalent 26Ω series resistors
- Operating voltage range:
 - V_{CC} (Opr) = 2.0V to 3.6V
- Pin and function compatible with 74 series 16245
- Latch-up performance exceeds 500mA (JESD 17)
- ESD performance:
- HBM > 2000V (MIL STD 883 method 3015); N.N. > 200V



Description

The 74LCXR162245 is a low voltage CMOS 16 bit bus transceiver (3-state) fabricated with submicron silicon gate and double-layer metal wiring C²MOS technology. It is ideal for low power and high speed 3.31/ applications; it can be interfaced to 5V signal environment for both inputs and outputs

Thic!(, is intended for two-way asynchronous cor imunication between data buses; the direction of data transmission is determined by DIR input.

The two enable inputs $n\overline{G}$ can be used to disable the device so that the buses are effectively isolated.

All outputs are designed to sink up to 12mA and include a 26Ω series resistor to reduce overshoot and undershoot.

All inputs and outputs are equipped with protection circuits against static discharge, giving them 2KV ESD immunity and transient excess voltage.

All floating bus terminals during High Z State must be held HIGH or LOW.

Order codes

Part number	Package	Packaging
74LCXR162245TTR	TSSOP48	Tape and reel

August 2006 Rev 4 1/15

www.st.com

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1 Logic symbols and I/O equivalent circuit

Figure 1. IEC logic symbols

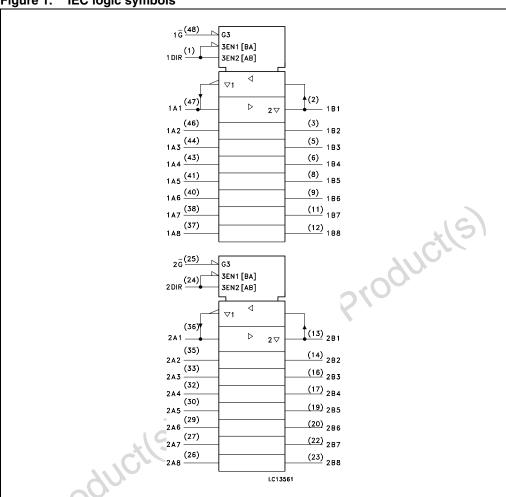
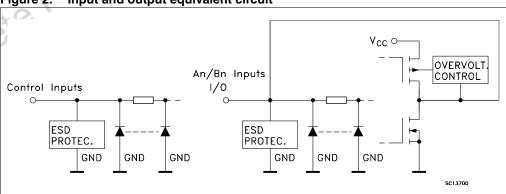


Figure 2. Input and output equivalent circuit

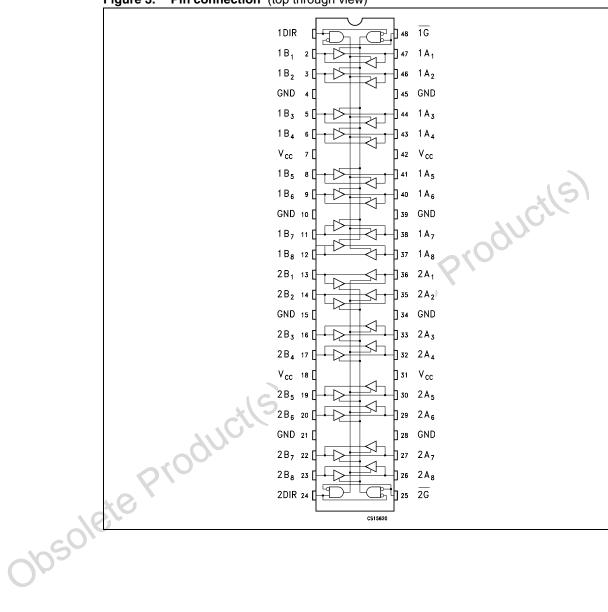


Pin settings 74LCXR162245

2 Pin settings

2.1 Pin connection

Figure 3. Pin connection (top through view)



74LCXR162245 Logic states

Pin description 2.2

Table 1. Pin description

-		
Pin N°	Symbol	Name and function
1	1DIR	Directional control
2, 3, 5, 6, 8,9, 11, 12	1B1 to 1B8	Data Inputs/Outputs
13, 14, 16, 17, 19, 20, 22, 23	2B1 to 2B8	Data Inputs/Outputs
24	2DIR	Directional control
25	2 G	Output enable input
36, 35, 33, 32, 30, 29, 27, 26	2A1 to 2A8	Data Inputs/Outputs
47, 46, 44, 43, 41, 40, 38, 38	1A1 to 1A8	Data Inputs/Outputs
48	1 G	Output enable input
4, 10, 15, 21, 28, 34, 39, 45	GND	Ground (0V)
7, 18, 31, 42	V _{CC}	Positive supply voltage
Logic states	abe	olete
Truth table	Ob	
Table 2. Truth table	.(5)	

Logic states 3

3.1 **Truth table**

Table 2. Truth table

Inp	uts	Fund	Output	
G	DIR	A BUS	B BUS	Yn
40	L	Output	Input	A = B
L	Н	Input	Output	B = A
Н	X	Z	Z	Z

X : Do not care

Z: High impedance

Maximum rating 74LCXR162245

4 Maximum rating

Stressing the device above the rating listed in the "absolute maximum ratings" table may cause permanent damage to the device. these are stress ratings only and operation of the device at these or any other conditions above those indicated in the operating sections of this specification is not implied. exposure to absolute maximum rating conditions for extended periods may affect device reliability. refer also to the STMicroelectronics sure program and other relevant quality documents.

Table 3. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{CC}	Supply voltage	-0.5 to +7.0	٧
V _I	DC input voltage (DIR, G)	-0.5 to +7.0	V
V _{I/O}	Bus I/O voltage (OFF State)	-0.5 to +7.0	٧
V _{I/O}	Bus I/O voltage (high or low state) (1)	-0.5 to V _{CC} + 0.5	٧
I _{IK}	DC input diode current	- 50	mA
I _{OK}	DC output diode current (2)	- 50	mA
Io	DC output current	±50	mA
I _{CC}	DC supply current per supply pin	±100	mA
I _{GND}	DC ground current per supply pin	±100	mA
T _{stg}	Storage temperature	-65 to +150	°C
T _L	Lead temperature (10 sec)	300	°C

^{1.} I_O absolute maximum rating must be observed

4.1 Recommended operating conditions

Table 4. Recommended operating conditions

Symsbol	Parameter	Value	Unit
V _{CC}	Supply voltage ⁽¹⁾	2.0 to 3.6	V
V_{I}	Input voltage	0 to 5.5	٧
Vo	Output voltage (OFF state)	0 to 5.5	V
V _O	Output voltage (high or low state)	0 to V _{CC}	V
I _{OH} , I _{OL}	High or low level output current (V _{CC} = 3.0 to 3.6V)	±12	mA
I _{OH} , I _{OL}	High or low level output current (V _{CC} = 2.7V)	±8	mA
T _{op}	Operating temperature	-40 to 85	°C
dt/dv	Input rise and fall time (2)	0 to 10	ns/V

^{1.} Truth table guaranteed: 1.5V to 3.6V

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 $^{2. \}quad V_O < GND$

^{2.} V_{IN} from 0.8V to 2V at $V_{CC} = 3.0V$

5 Electrical characteristics

Table 5. DC specifications

	-	Te	est condition	Value		Unit		
Symbol	Parameter	V _{CC}		-40 to				
		(V)		Min	Max			
V _{IH}	High level input voltage	2.7 to 3.6		2.0		V		
V _{IL}	Low level input voltage	2.7 10 3.0			0.8	V		
		2.7 to 3.6	I _O = -100 μA	V _{CC} -0.2				
V_{OH}	High level output voltage	2.7	I _O = -8 mA	2.0		V		
VOH	nigh level output voltage	2.0	I _O = -6 mA	2.4		v		
		3.0	I _O = -12 mA	2.2				
		2.7 to 3.6	I _O = 100 μA		0.2			
V.	Low lovel output voltage	2.7	I _O = 8 mA		0.6	v		
V _{OL}	Low level output voltage	3.0	I _O = 6 mA	00,	0.55	ľ		
			I _O = 12 mA		0.8			
I _I	Input leakage current	2.7 to 3.6	V _I = 0 to 5.5V		±5	μΑ		
I _{off}	Power OFF leakage current	0	V_I or $V_O = 5.5V$		10	μΑ		
I _{OZ}	High impedance output leakage current	2.7 to 3.6	$V_I = V_{IH} \text{ or } V_{IL}$ $V_O = 0 \text{ to } V_{CC}$		±5	μΑ		
				0.740.0.0	V _I = V _{CC} or GND		20	
I _{CC}	Quiescent supply current	2.7 to 3.6	V _I or V _O = 3.6 to 5.5V		±20	μΑ		
Δl _{CC}	I _{CC} incr. per Input	2.7 to 3.6	V _{IH} = V _{CC} - 0.6V		500	μΑ		

Table 6. Dynamic switching characteristics

		Те	Value				
Symbol	Parameter	V _{CC}		T,	_A = 25 °	C	Unit
		(V)		Min	Тур	Max	
V _{OLP}	Dynamic low level quiet	3.3	$C_L = 50pF$ $V_{IL} = 0V, V_{IH} = 3.3V$		0.35		٧
V _{OLV}	output ⁽¹⁾	5.5	$V_{IL} = 0V, V_{IH} = 3.3V$		-0.35		V

Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH to LOW or LOW to HIGH. The remaining output is measured in the LOW state.

Electrical characteristics 74LCXR162245

Table 7. AC electrical characteristics

		Test condition				Va		
Symbol	Parameter	v _{cc}	C _L	R_{L}	t _s = t _r	-40 to 85 °C		Unit
		(V) (pF)	(Ω)	(ns)	Min	Max		
t _{PLH} t _{PHL}	Propagation delay	2.7	50	50 500	2.5	1.5	4.5	
PLH PHL	time	3.0 to 3.6	50 500 2.5	1.5	4.0	ns		
t _{PZL} t _{PZH}	Output enable	2.7	50	500	2.5	1.5	5.8	- ns
PZL PZH	time	3.0 to 3.6	5		2.5	1.5	5.3	
t _{PLZ} t _{PHZ}	Output disable	2.7	50	500	2.5	1.5	5.8	ns
time		3.0 to 3.6	5	300	2.9	1.5	5.4	115
t _{OSLH} t _{OSHL}	Output to output skew time (1) (2)	3.0 to 3.6	50	500	2.5		1.0	ns

Skew is defined as the absolute value of the difference between the actual propagation delay for any two outputs of the same device switching in the same direction, either HIGH or LOW
 (t_{OSLH} = | t_{PLHm} - t_{PLHm}|, t_{OSHL} = | t_{PHLm} - t_{PHLm}|)

Table 8. Capacitive characteristics

		Test condition Value					
Symbol	Parameter	V _{CC}		T	_A = 25 °	С	Unit
		(V)	.0,	Min	Тур	Max	
C _{IN}	Input capacitance	3.3	$V_{IN} = 0$ to V_{CC}		7		pF
C _{OUT}	Output capacitance	3.3	$V_{IN} = 0$ to V_{CC}		8		pF
C _{PD}	Power dissipation capacitance ⁽¹⁾	3.3	$f_{IN} = 10MHz$ $V_{IN} = 0 \text{ or } V_{CC}$		80		pF

C_{PD} is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average operating current can be obtained by the following equation. I_{CC(opr)} = C_{PD} x V_{CC} x f_{IN} + I_{CC}/16 (per circuit)

In the operating current can be obtained by the following equation. I_{CC(opr)} = C_{PD} x V_{CC} x f_{IN} + I_{CC}/16 (per circuit)

^{2.} Parameter guaranteed by design

74LCXR162245 Test circuit

6 Test circuit

Figure 4. Test circuit

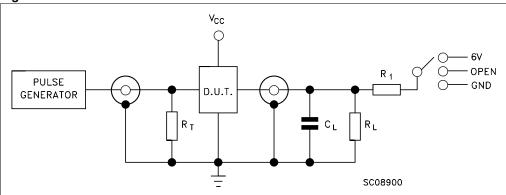


Figure 5. Test circuit

Test	Switch
t _{PLH} , t _{PHL}	Open
t _{PZL} , t _{PLZ}	6V
t _{PZH} , t _{PHZ}	GND

 $C_L = 50 pF$ or equivalent (includes jig and probe capacitance)

 $R_L = R_1 = 500\Omega$ or equivalent

 $R_T = Z_{OUT}$ of pulse generator (typically 50 Ω)

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Waveforms 74LCXR162245

7 Waveforms

Figure 6. Propagation delays (f = 1MHz; 50% duty cycle)

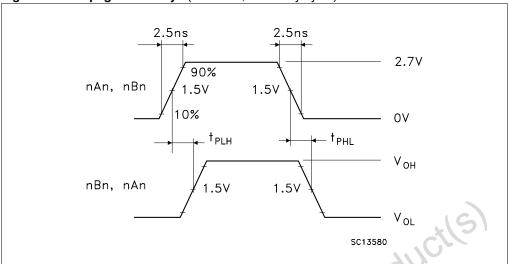
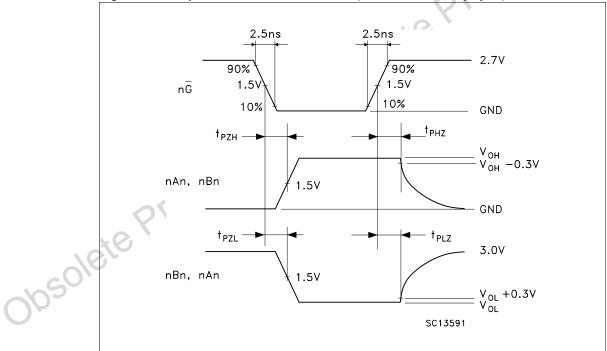


Figure 7. Output enable and disable time (f = 1MHz; 50% duty cycle)



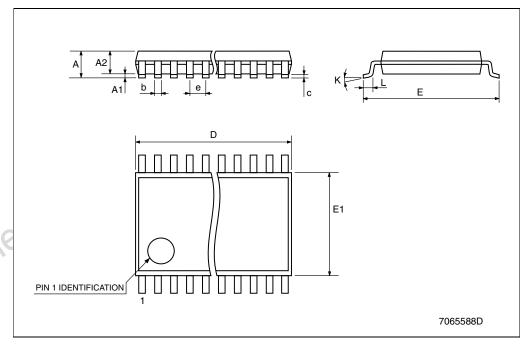
8 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com

Obsolete Product(s). Obsolete Product(s)

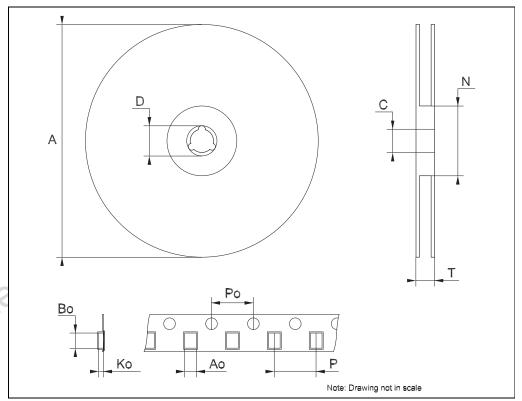
TSSOP48 MECHANICAL DATA

DIM.		mm.			inch	
DIW.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
А			1.2			0.047
A1	0.05		0.15	0.002		0.006
A2		0.9			0.035	
b	0.17		0.27	0.0067		0.011
С	0.09		0.20	0.0035		0.0079
D	12.4		12.6	0.488		0.496
Е		8.1 BSC			0.318 BSC	
E1	6.0		6.2	0.236		0.244
е		0.5 BSC			0.0197 BSC	
К	0°		8°	0°		8°
L	0.45		0.75	0.018		0.030



Tape & Reel TSSOP48 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
А			330			12.992
С	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	60			2.362		
Т			30.4			1.197
Ao	8.7		8.9	0.343		0.350
Во	13.1		13.3	0.516		0.524
Ko	1.5		1.7	0.059		0.067
Po	3.9		4.1	0.153		0.161
Р	11.9		12.1	0.468		0.476



Revision history 74LCXR162245

9 Revision history

Table 9. Revision history

Date	Revision	Changes
15-Sep-2004	3	Ordering Codes Revision - pag. 1.
30-Aug-2006	4	New template, temperature ranges updated



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